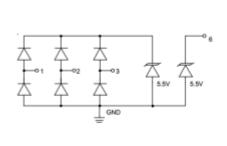
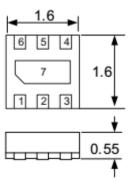


Description

The JLE05URF6-6 is a low capacitance TVS array, utilizing leading monolithic silicon technology to provide fast response time and low ESD clamping voltage, making this device an ideal solution for protecting voltage sensitive high-speed data lines. The JLE05URF6-6 complies with the IEC 61000-4-2 (ESD) standard with ± 25 kV air and ± 20 kV contact discharge. It is assembled into a 6-pin DFN1616- 6 lead-free package. The leads are finished with NiPdAu. Each device will protect up to four high-speed lines. The combination of small size, low capacitance, and high surge capability makes them ideal for use in applications such as cellular phones, LCD displays, USB, and multi media card interfaces.

Circuit Diagram





Circuit and Pin Schematic

Marking Diagram



Transparent top view

53M:Device Marking Code

Features

- * 75W peak pulse power (8/20μs)
- * Low leakage:nA level
- * Operating voltage: 5V
- * Low clamping voltage
- * Up to 3 lines and one power line protects
- * Complies with following standards:

- IEC 61000-4-2 (ESD) immunity test

Air discharge: ±25kV

Contact discharge: ±20kV

- IEC61000-4-5 (Lightning) 5A (8/20µs)
- * RoHS Compliant
- Package: DFN1616-6

Applications

- * USB2.0 and USB OTG
- * Molti Media Card Interfaces
- * SD Card Interfaces
- * MDDI Ports
- * SIM Ports

Ordering Information

Part Number	Packaging	Reel Size
JLE05URF6-6	3000/Tape & Reel	7 inch



Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
DP,DM,USB ID (Pins 1,2,3)			
Peak Pulse Power (8/20µs)	Ppk	75	W
Peak Pulse Current (8/20µs)	IPP	5	А
ESD per IEC 61000-4-2 (Air)	VESD	±25	kV
ESD per IEC 61000-4-2 (Contact)	vESD	±20	K V
Operating Temperature Range	TJ	-55to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C
VBus (Pins 6)			
Peak Pulse Power (8/20µs)	Ppk	100	W
Peak Pulse Current (8/20µs)	IPP	8	А
ESD per IEC 61000-4-2 (Air)	VESD	±25	kV
ESD per IEC 61000-4-2 (Contact)	vESD	±20	K V
Operating Temperature Range	TJ	-55to +125	°C
Storage Temperature Range	Tstg	-55 to +150	°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Reverse Working Voltage	VRWM	Pin 1,2, or 3 to ground			5	V
Breakdown Voltage	VBR	IT = 1mA,pin 6 to ground	6			V
Reverse Leakage Current	I _R	V _{RWM} = 5V,pin 6 to ground			0.5	uA
Clamping Voltage	Vc	$I_{PP} = 1A (8 \times 20 \mu s \text{ pulse}), \text{ any I/O pin to ground}$			10	V
Clamping Voltage	Vc	IPP = 5A (8 x 20 μ s pulse), any I/O pin to ground			15	V
Junction Capacitance	Сл	VR = 0V, f = 1MHz, between I/O pins			0.4	pF
Junction Capacitance	Сл	VR = 0V, $f = 1MHz$, any I/O pin to ground		0.6	0.8	pF

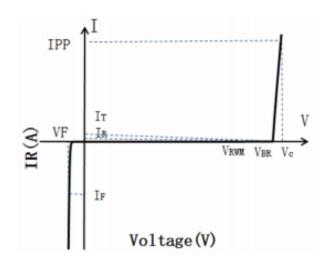


Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
VBus TVS						
Reverse Working Voltage	Vrwm	Pin 6 to ground			5.5	V
Breakdown Voltage	VBR	IT = 1mA,pin 6 to ground	6		8.5	V
Reverse Leakage Current	I _R	V _{RWM} = 5.5V,pin 6 to ground			0.5	uA
Clamping Voltage	Vc	IPP = $1A$ (8 x 20µs pulse), pin 6 to ground			8	V
Clamping Voltage	Vc	IPP = $8A$ (8 x 20µs pulse), pin 6 to ground			12	V
Junction Capacitance	Сл	VR = 0V, f = 1MHz, pin 6 to ground		60		pF

Portion Electronics Parameter

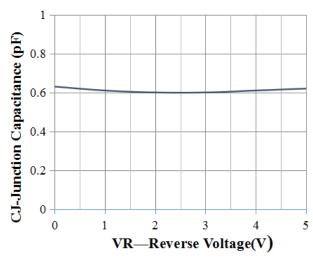
Symbol	Parameter	
Іт	Test Current	
Ірр	Maximum Reverse Peak Pulse Current	
Vc	Clamping Voltage @Ic	



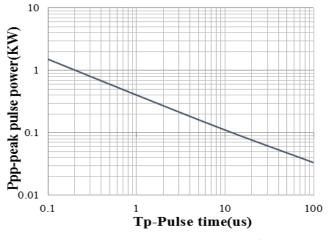


JLE05URF6-6

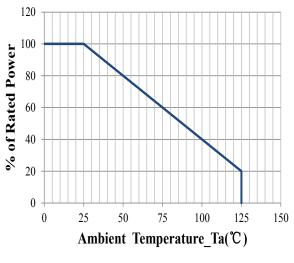




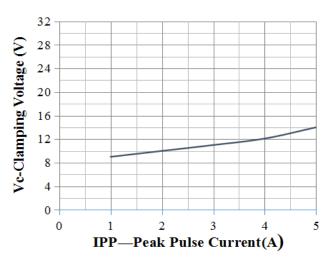
Junction Capacitance vs. Reverse Voltage



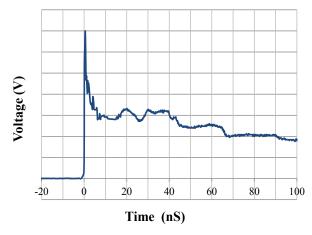
Peak Pulse Power vs. Pulse Time



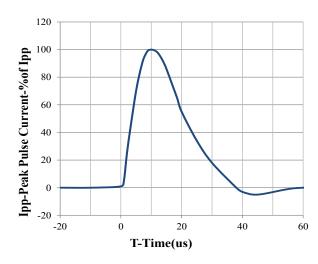
Power Derating Curve



Clamping Voltage vs. Peak Pulse Current



IEC61000-4-2 Pulse Waveform

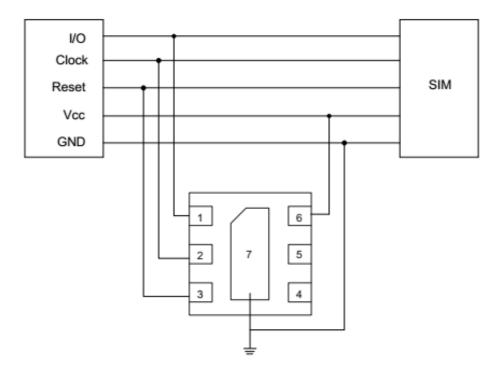


8 X 20us Pulse Waveform

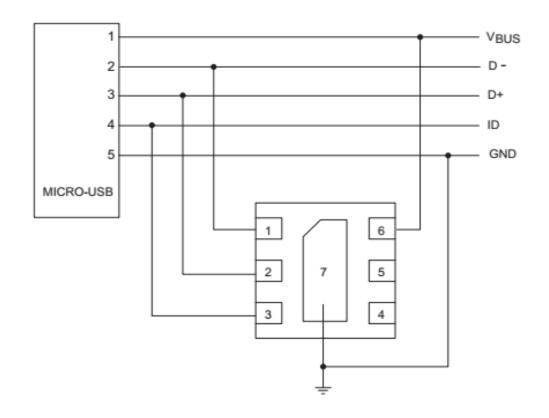


JLE05URF6-6

On SIM Port Application

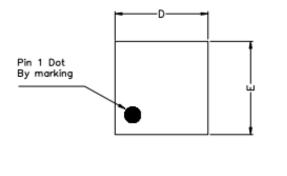


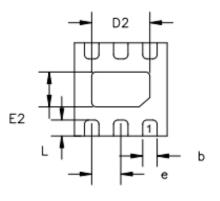
On USB Port Application



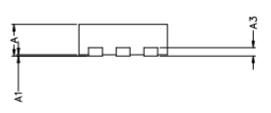


DFN1616-6 Package Outline Drawing (Dimensions in millimeters)





TOP VIEW

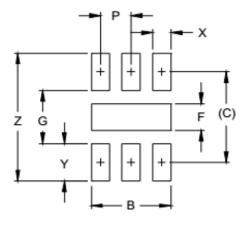


<u>B0</u>	TΤ	ΟM	VIEW	

COMMON DIMENSIONS(MM)			
PKG.	U1	ULTRA THIN	
REF.	MIN.	NOM.	MAX
A	0.50	0.55	0.60
A1	0.00	-	0.05
A3	0.15 REF.		
D	1.55	1.60	1.65
E	1.55	1.60	1.65
D2	0.90	1.00	1.05
E2	0.50	0.60	0.65
L	0.20	0.25	0.30
ь	0.20	0.25	0.30
e	0.50 BSC		

SIDE VIEW

Suggested Land Pattern



	DIMENSIONS		
DIM	INCHES	MILLIMETERS	
В	.051	1.30	
С	.060	1.52	
Р	.020	0.50	
F	.018	0.45	
G	.035	0.89	
Х	.012	0.30	
Y	.025	0.63	
Z	.085	2.15	

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